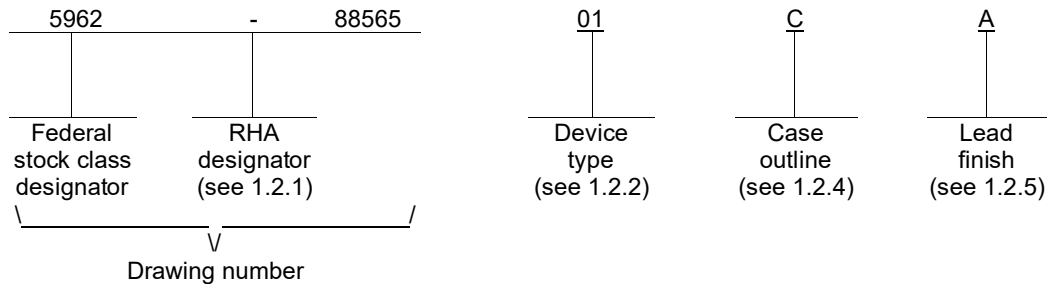


1. SCOPE

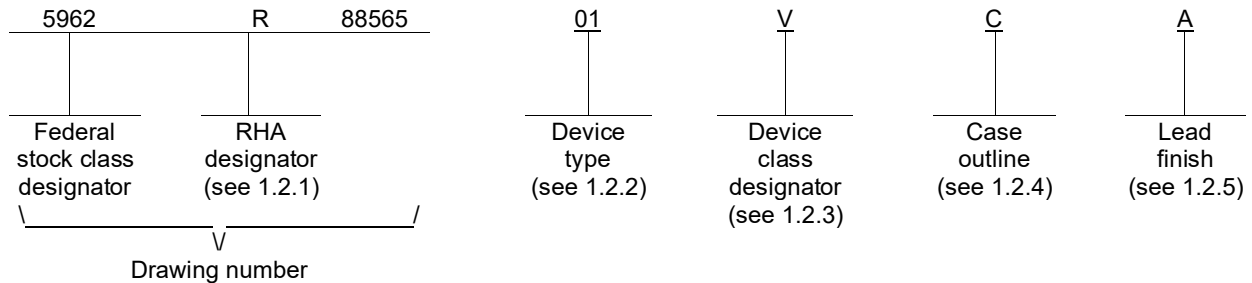
1.1 Scope. This drawing documents two product assurance class levels consisting of high reliability (device class Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels is reflected in the PIN.

1.2 PIN. The PIN is as shown in the following example:

For device class M and Q:



For device class V:



1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device type(s). The device type(s) identify the circuit function as follows:

<u>Device type</u>	<u>Generic number</u>	<u>Circuit function</u>
01	OP-470A	Very low noise, quad, operational amplifier
02	OP-471A	High speed, low noise, quad, operational amplifier
03	OP-470A	Very low noise, quad, operational amplifier
04	OP-471A	High speed, low noise, quad, operational amplifier

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as follows:

<u>Device class</u>	<u>Device requirements documentation</u>
M	Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Q or V	Certification and qualification to MIL-PRF-38535

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1.2.4 Case outline(s). The case outline(s) are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
C	GDIP1-T14 or CDIP2-T14	14	Dual-in-line
D	GDFP1-F14 or CDFP2-F14	14	Flat pack
2	CQCC1-N20	20	Square leadless chip carrier
3	CQCC1-N28	28	Square leadless chip carrier
K	GDFP2-F24 or CDFP3-F24	24	Flat pack

1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

1.3 Absolute maximum ratings. ^{1/}

Supply voltage (VCC)	±18 V dc
Differential input voltage	±1 V dc ^{2/}
Differential input current	±25 mA ^{2/}
Input voltage	Supply voltage
Output short circuit duration	Continuous
Storage temperature range	-65°C to +150°C
Lead temperature (soldering, 60 seconds)	+300°C
Power dissipation (PD):	
Cases C and 2	800 mW
Case D	550 mW
Case 3	500 mW
Case K	440 mW
Maximum junction temperature (T _J)	+150°C
Thermal resistance, junction-to-case (θ _{JC})	See MIL-STD-1835
Thermal resistance, junction-to-ambient (θ _{JA}):	
Cases C and 2	100°C/W
Case D	140°C/W
Case 3	110°C/W
Case K	69°C/W

1.4 Recommended operating conditions.

Ambient operating temperature range (T _A)	-55°C to +125°C
Supply voltage (VCC)	±15 V

1.5 Radiation features.

Device types 01 and 02:	
Maximum total dose available (dose rate = 50 – 300 rads(Si)/s)	100 krads(Si) ^{3/}
Device types 03 and 04:	
Maximum total dose available (dose rate ≤ 10 mrads(Si)/s)	50 krads (Si) ^{4/}

- ^{1/} Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- ^{2/} The inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise performance. If the differential input voltage exceeds ±1 V, the input current should be limited to ±25 mA.
- ^{3/} Device types 01 and 02 may be dose rate sensitive in a space environment and may demonstrate enhanced low dose rate effects. Radiation end point limits for the noted parameters are guaranteed only for the conditions specified in MIL-STD-883, method 1019, condition A.
- ^{4/} For device type 03 and 04, radiation end point limits for the noted parameters are guaranteed for the conditions specified in MIL-STD-883, method 1019, condition D.

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2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those cited in the solicitation or contract.

DEPARTMENT OF DEFENSE SPECIFICATION

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

MIL-STD-883 - Test Method Standard Microcircuits.
MIL-STD-1835 - Interface Standard Electronic Component Case Outlines.

DEPARTMENT OF DEFENSE HANDBOOKS

MIL-HDBK-103 - List of Standard Microcircuit Drawings.
MIL-HDBK-780 - Standard Microcircuit Drawings.

(Copies of these documents are available online at <https://quicksearch.dla.mil/>.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 as specified herein, or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.4 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.3 Radiation exposure circuit. The radiation exposure circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing and acquiring activity upon request.

3.3 Electrical performance characteristics and postirradiation parameter limits. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.

3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.

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TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions <u>1/ 2/</u> -55°C ≤ TA ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit	
					Min	Max		
Input offset voltage	VIO		1	01, 03		±0.4	mV	
			2, 3			±0.6		
			M,D,P,L,R	1	01			±0.6
			M,D,P,L	1	03			±0.6
				1	02, 04			±0.8
				2, 3				±1.2
			M,D,P,L,R	1	02			±1.0
			M,D,P,L	1	04			±1.0
Input offset current	IIO	VCM = 0 V	1	All		±10	nA	
			2, 3			±20		
			M,D,P,L,R	1	01, 02			50
			M,D,P,L	1	03, 04			50
Input bias current	IIB	VCM = 0 V	1	All		±25	nA	
			2, 3			±50		
			M,D,P,L,R	1	01, 02			±500
			M,D,P,L	1	03, 04			±500
Input noise voltage	En	fo = 1 Hz to 100 Hz, <u>3/</u> TA = +25°C	7	01, 03		110	nV	
				02, 04		265	RMS	
Large-signal voltage gain	AVS	VO = ±10 V, RL = 10 kΩ	4	01, 03	1000		V/mV	
			5, 6			750		
			M,D,P,L,R	4	01	100		
			M,D,P,L	4	03	100		
				4	01, 03	500		
				5, 6		400		
				4	02, 04	500		
				5, 6		375		
	M,D,P,L,R	4	02	50				
	M,D,P,L	4	04	50				

See footnotes at end of table.

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TABLE I. Electrical performance characteristics – Continued.

Test	Symbol	Conditions <u>1/</u> <u>2/</u> -55°C ≤ TA ≤ +125°C unless otherwise specified	Group A subgroups	Device type	Limits		Unit	
					Min	Max		
Large-signal voltage gain	AVS	VO = ±10 V, <u>3/</u> RL = 2 kΩ	4	02, 04	350		V/mV	
			5, 6		250			
Output voltage swing	VOP	RL = 2 kΩ <u>3/</u>	4, 5, 6	All	±12		V	
Supply current <u>4/</u>	IS	No load	1, 2, 3	All		11	mA	
			M,D,P,L,R	1	01, 02			11
			M,D,P,L	1	03, 04			11
Slew rate	SR	AVCL = +21, RL = 10 kΩ, TA = +25°C <u>3/</u>	7	01, 03	1.4		V/μs	
				02, 04	6.5			
Common-mode rejection	CMR	VCM = IVR = ±11 V <u>3/</u> <u>5/</u>	1	01, 03	110		dB	
			2, 3		100			
			1	02, 04	105			
			2, 3		100			
Power supply rejection ratio	PSRR	VCC = ±4.5 V to ±18 V <u>3/</u>	1	01, 03		1.8	μV/V	
			2, 3			5.6		
			1	02, 04		5.6		
			2, 3			10		

- 1/ Device types 01 and 02 supplied to this drawing has been characterized through all levels M, D, P, L, R of irradiation. Device types 03 and 04 supplied to this drawing has been characterized through all levels M, D, P, L of irradiation. However, device types 01 and 02 is only tested at the "R" level and device types 03 and 04 is only tested at the "L" level. Pre and Post irradiation values are identical unless otherwise specified in Table I. When performing post irradiation electrical measurements for any RHA level, TA = +25°C. VCC = ±15 V, RS = 50 Ω.
- 2/ For device types 01 and 02, these parts may be dose rate sensitive in a space environment and may demonstrate enhanced low dose rate effects. Radiation end point limits for the noted parameters are guaranteed only for the conditions specified in MIL-STD-883, method 1019, condition A for device types 01 and 02 and condition D for device types 03 and 04. Device types 03 and 04, have been tested at low dose rate.
- 3/ This parameter is not tested post-irradiation.
- 4/ IS limit equals the total of all amplifiers.
- 5/ IVR is defined as the VCM range used for the CMR test.

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Device types	01, 02, and 03, 04			
Case outlines	C and D	K	2	3
Terminal number	Terminal symbol			
1	OUT A	OUT A	NC	NC
2	-IN A	-IN A	OUT A	OUT A
3	+IN A	NC	-IN A	-IN A
4	+VCC	NC	+IN A	NC
5	+IN B	+IN A	NC	NC
6	-IN B	+VCC	+VCC	+IN A
7	OUT B	+IN B	NC	NC
8	OUT C	NC	+IN B	+VCC
9	-IN C	NC	-IN B	NC
10	+IN C	NC	OUT B	+IN B
11	-Vcc	-IN B	NC	NC
12	+IN D	OUT B	OUT C	NC
13	-IN D	OUT C	-IN C	-IN B
14	OUT D	-IN C	+IN C	OUT B
15	---	NC	NC	NC
16	---	NC	-Vcc	OUT C
17	---	NC	NC	-IN C
18	---	+IN C	+IN D	NC
19	---	-Vcc	-IN D	NC
20	---	+IN D	OUT D	+IN C
21	---	NC	---	NC
22	---	NC	---	-Vcc
23	---	-IN D	---	NC
24	---	OUT D	---	+IN D
25	---	---	---	NC
26	---	---	---	NC
27	---	---	---	-IN D
28	---	---	---	OUT D

NC = No connection.

FIGURE 1. Terminal connections.

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3.5.1 Certification/compliance mark. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

3.6 Certificate of compliance. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DLA Land and Maritime-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.

3.7 Certificate of conformance. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change for device class M. For device class M, notification to DLA Land and Maritime-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change that affects this drawing.

3.9 Verification and review for device class M. For device class M, DLA Land and Maritime, DLA Land and Maritime's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 Microcircuit group assignment for device class M. Device class M devices covered by this drawing shall be in microcircuit group number 49 (see MIL-PRF-38535, appendix A).

4. VERIFICATION

4.1 Sampling and inspection. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.

(2) $T_A = +125^{\circ}\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table IIA herein.

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TABLE IIA. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)	1	1	1
Final electrical parameters (see 4.2)	1,2,3,4,5,6 <u>1/</u>	1,2,3,4,5,6 <u>1/</u>	1,2,3,4, <u>1/ 2/</u> 5,6
Group A test requirements (see 4.4)	1,2,3,4,5,6,7	1,2,3,4,5,6,7	1,2,3,4,5,6,7
Group C end-point electrical parameters (see 4.4)	1	1	1 <u>2/</u>
Group D end-point electrical parameters (see 4.4)	1	1	1
Group E end-point electrical parameters (see 4.4)	---	---	1, 4

1/ PDA applies to subgroup 1.

2/ Delta limits as specified in table IIB shall be required where specified, and the delta limits shall be computed with reference to the previous interim electrical parameters.

TABLE IIB. Burn-in and operating life test delta parameters. TA = +25°C. 1/ 2/

Parameter	Device types	Limit		Delta	
		Min	Max	Min	Max
VOS	01, 03		0.4 mV		100 μV
	02, 04		0.8 mV		250 μV
IOS	01, 03		10 nA		5 nA
	02, 04		10 nA		5 nA
IB	01, 03		±25 nA		5 nA
	02, 04		±25 nA		5 nA

1/ Deltas are performed at room temperature.

2/ 240 hour burn-in and 1,000 hour operating group C life test.

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4.2.2 Additional criteria for device classes Q and V.

- a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1015 of MIL-STD-883.
- b. Interim and final electrical test parameters shall be as specified in table IIA herein.
- c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections, and as specified herein. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4.1 Group A inspection.

- a. Tests shall be as specified in table IIA herein.
- b. Subgroups 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.

4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.

4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:

- a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.
- b. $T_A = +125^\circ\text{C}$, minimum.
- c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in method 1005 of MIL-STD-883.

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4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.

4.4.4 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table IIA herein.
- b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535 for the RHA level being tested. For device class M, the devices shall be subjected to radiation hardness assured tests as specified in MIL-PRF-38535, appendix A for the RHA level being tested. All device classes must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^{\circ}\text{C} \pm 5^{\circ}\text{C}$, after exposure, to the subgroups specified in table IIA herein.

4.4.4.1 Total dose irradiation testing. Total dose irradiation testing shall be performed in accordance with MIL-STD-883 method 1019, condition A for device types 01 and 02, condition D for device types 03 and 04 and as specified herein.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor prepared specification or drawing.

6.2 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished using DD Form 1692, Engineering Change Proposal, or email communication.

6.3 Record of users. Military and industrial users should inform DLA Land and Maritime when a system application requires configuration control and which SMD's are applicable to that system. DLA Land and Maritime will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DLA Land and Maritime-VA, telephone (614) 692-8108.

6.4 Comments. Comments on this drawing should be directed to DLA Land and Maritime-VA, Columbus, Ohio 43218-3990, or telephone (614) 692-0591.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.

6.6 Sources of supply.

6.6.1 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in MIL-HDBK-103 and QML-38535. The vendors listed in MIL-HDBK-103 and QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DLA Land and Maritime-VA and have agreed to this drawing.

6.6.2 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DLA Land and Maritime-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 24-02-02

Approved sources of supply for SMD 5962-88565 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML-38535 during the next revision. MIL-HDBK-103 and QML-38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DLA Land and Maritime-VA. This information bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML-38535. DLA Land and Maritime maintains an online database of all current sources of supply at <https://landandmaritimeapps.dla.mil/programs/smcr/>.

Standard microcircuit drawing PIN <u>1</u> /	Vendor CAGE number	Vendor similar PIN <u>2</u> /
5962-8856501CA	24355	OP-470AY/883C
5962-88565012A	24355	OP-470ARC/883C
5962-88565013A	<u>3</u> /	OP-470ATC/883C
5962-8856502CA	24355	OP-471AY/883C
5962-88565022A	24355	OP-471ARC/883C
5962-88565023A	24355	OP-471ATC/883C
5962-8856501VCA	<u>3</u> /	OP470AY
5962-8856501V2A	24355	OP470ARC/QMLV
5962-8856501VKA	<u>3</u> /	OP470AN/QMLV
5962-8856502VCA	<u>3</u> /	OP471AY/QMLV
5962-8856502VDA	<u>3</u> /	OP471AM/QMLV
5962-8856502V2A	<u>3</u> /	OP471ARC/QMLV
5962-8856502VKA	<u>3</u> /	OP471AN/QMLV
5962R8856501VCA	24355	OP470AY/QMLR
5962R8856501V2A	24355	OP470ARC/QMLR
5962R8856501VKA	24355	OP470AN/QMLR

See footnotes at end of table.

STANDARD MICROCIRCUIT DRAWING BULLETIN - CONTINUED

DATE: 24-02-02

Standard microcircuit drawing PIN <u>1/</u>	Vendor CAGE number	Vendor similar PIN <u>2/</u>
5962R8856502VCA	24355	OP471AY/QMLR
5962R8856502VDA	24355	OP471AM/QMLR
5962R8856502V2A	<u>3/</u>	OP471ARC/QMLR
5962R8856502VKA	24355	OP471AN/QMLR
5962L8856503VCA	24355	OP470AY/QMLL
5962L8856504VDA	24355	OP471AM/QMLL

1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. If the desired lead finish is not listed contact the vendor to determine its availability.

2/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

3/ Not available from an approved source of supply.

Vendor CAGE number

24355

Vendor name and address

Analog Devices
Route 1 Industrial Park
P.O. Box 9106
Norwood, MA 02062
Point of contact: 804 Woburn Street
Wilmington, MA 01887-3462

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